

DISCRETE SOCKETS



✓ Active

TE CONNECTIVITY (TE)

SOCKET, MIN-SPR W/KO SN-AU S-3

MINI-SPRING SOCKETS | Series 4

3-5331677-2

TE Internal Number: 3-5331677-2

EU RoHS Compliant

EU ELV Compliant

Hole Size (Recommended) 1.57 mm [.062 in]

Socket Length 3.51 mm [.138 in]

Sealant Without

Sleeve Style Knockout Bottom

Wire/Cable Size .326 – .41 mm² [22 – 21 AWG]



PRODUCT DRAWING

English



→ 3D PDF

DOCUMENTATION

Product Drawings

MINIATURE SPRING SOCKET ASSEMBLY

PDF

English

CAD Files

Customer View Model

3D_IGS.ZIP

English

Customer View Model

3D_STP.ZIP

English

Customer View Model 2D_DXF.ZIP

3D PDF

English

PDF

English

Product Environmental Compliance

TE Material Declaration

MD_3-5331677-2_06222015721_dmtec

PDF

English

FEATURES

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Please review product documents or contact us for the latest agency approval information.

Please Note: Use the Product Drawing for all design activity.

Product Type Features

Sleeve Style Knockout Bottom

Connector System Cable-to-Board

Sealable No

Connector & Contact Terminates To Printed Circuit Board

Product Type Contact

Profile Zero
Wire/Cable Type Discrete Wire

Body Features

Sealant Without
Sleeve Plating Material Tin
Sleeve Material Copper

Contact Features

Contact Current Rating (Max) (A) 5, 6.5

Contact Type Socket

Contact Spring Plating Thickness .762 µm [30 µin]

Contact Spring Plating Material Gold

Contact Mating Area Plating Thickness 30 µm [30 µin]

Contact Transmits (Typical) Signal (Data)/Power

Contact Base Material Beryllium Copper

Termination Features

Socket Type Discrete

Termination Method to PC Board Through Hole - Press-Fit
Termination Method to Wire/Cable Solder
Insertion Method Hand/Semi-Automatic/Automatic

Dimensions

Socket Length 3.51 mm [.138 in] Hole Size (Recommended) 1.57 mm [.062 in] Wire/Cable Size .326 – .41 mm² [22 – 21 AWG] **Mating Pin Diameter Range** .66 – .74 mm [.026 – .029 in] **PCB Thickness (Recommended)** .79 – 3.18 mm [.031 – .125 in] **Usage Conditions Operating Temperature Range** -65 – 125 °C [-85 – 257 °F] Operation/Application Circuit Application Power, Signal Packaging Features Packaging Method Bag, Loose Piece Packaging Quantity 2000 Other **Spring Material** Beryllium Copper **PRODUCT COMPLIANCE** Statement of Compliance **Statement of Compliance** PDF